

2SJ399

Silicon P-Channel MOS FET

REJ03G0193-0200Z (Previous ADE-208-267 (Z)) Rev.2.00 Apr.05.2004

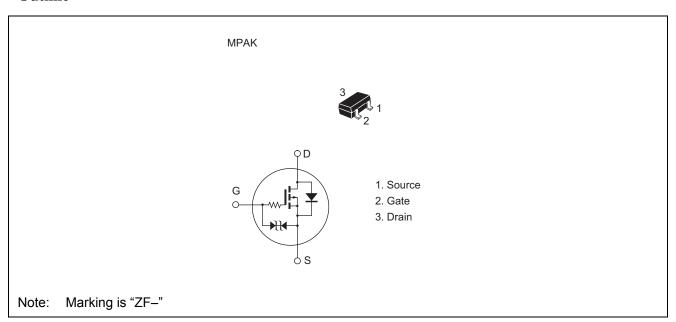
Application

Low frequency power switching

Features

- Low on-resistance
- Small package
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for low signal load switch.

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit	
Drain to source voltage	V_{DSS}	-30	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	I _D	-0.2	Α	
Drain peak current	I _{D(pulse)} Note	-0.4	Α	
Body to drain diode reverse drain current	I _{DR}	-0.2	А	
Channel dissipation	Pch	150	mW	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note: PW ≤ 100 µs, duty cycle ≤ 10%

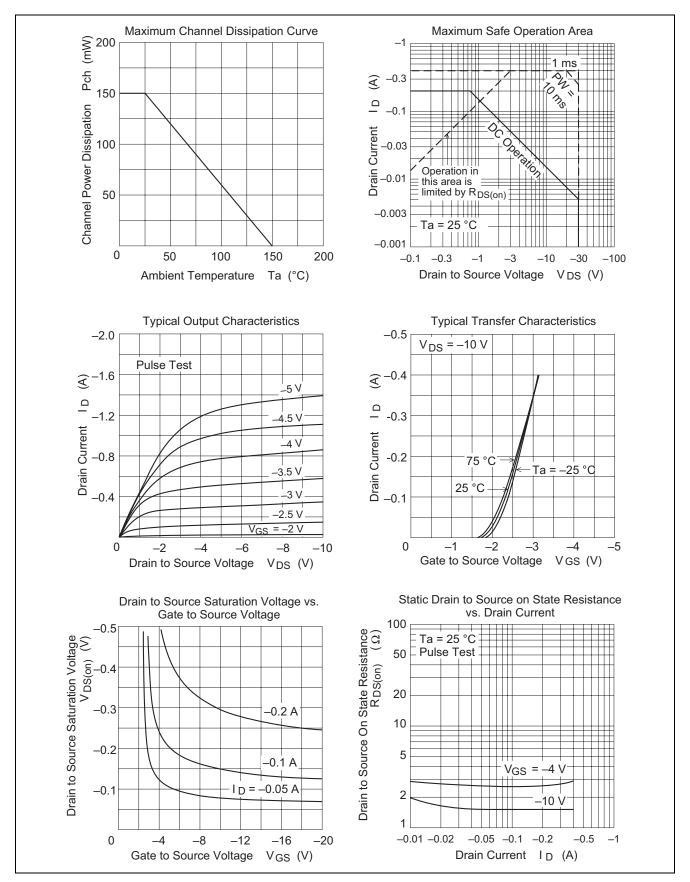
Electrical Characteristics

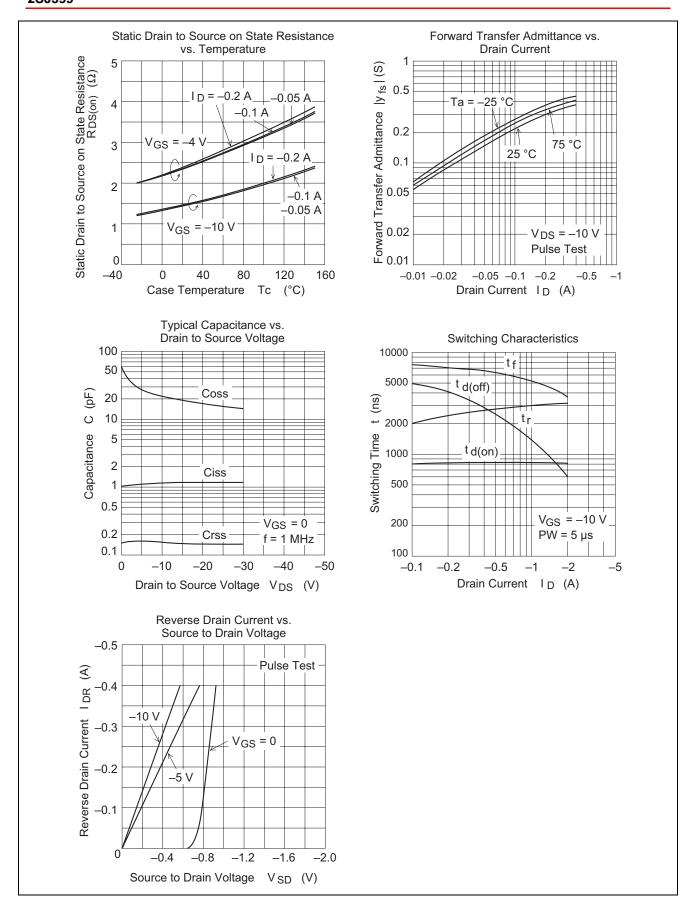
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	_	_	V	$I_D = -100 \mu A, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	_	_	V	$I_G = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±2	μΑ	V _{GS} = ±16 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	_	_	-1	μΑ	$V_{DS} = -30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	_	-2.0	V	$I_D = -10 \mu A, V_{DS} = -5 V$
Static drain to source on state	R _{DS(on)}	_	2.7	7.5	Ω	I _D = -20 mA, V _{GS} = -4 V
resistance		_	2.0	7.0	Ω	$I_D = -10 \text{ mA}, V_{GS} = -10 \text{ V}$
Input capacitance	Ciss	_	1.1	_	pF	V _{DS} = -10 V
Output capacitance	Coss	_	22.3	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	0.17	_	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	_	530	_	ns	I _D = -0.1 A
Rise time	t _r	_	2170	_	ns	V _{GS} = -10 V
Turn-off delay time	$t_{d(off)}$	_	7640	_	ns	$R_L = 100 \Omega$
Fall time	t _f	_	7690	_	ns	PW = 5 μs

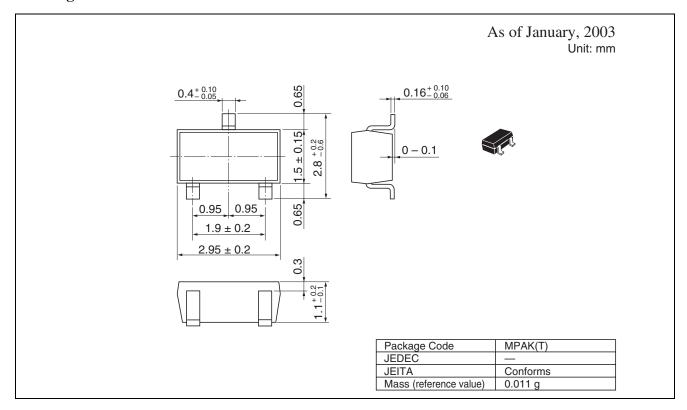
Note: Pulse Test

Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SJ399	3000 pcs	φ178 mm Taping Reel (TL)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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